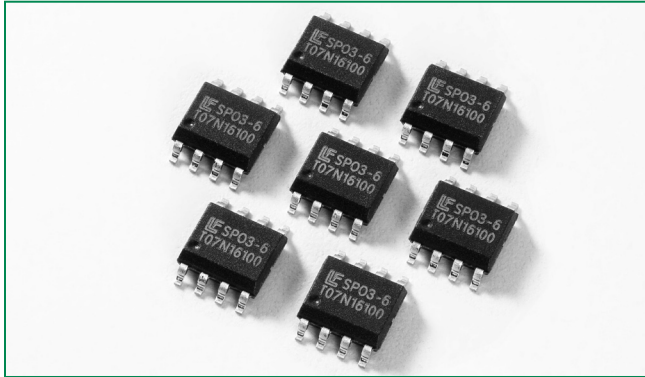


**HF** **RoHS** **Pb** **GREEN** **SP03-6 (SO-8) Series**



**Description**

This new broadband protection device from Littelfuse provides overvoltage protection for applications such as 10/100/1000 BaseT Ethernet, T3/E3 DS3 interfaces, ADSL2+, and VDSL2+. This new protector combines the TVS diode element with a diode rectifier bridge to provide both longitudinal and differential protection in one package. This design innovation results in a capacitive loading characteristic that is log-linear with respect to the signal voltage across the device. This reduces intermodulation (IM) distortion caused by a typical solid-state protection solution. The application schematic provides the connection information.

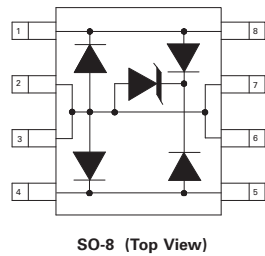
**Agency Approvals - Pending**

Agency	Agency File Number
	E128662

**Features**

- RoHS compliant
- MS-012 surface mount package (JEDEC SO-8)
- Low insertion loss, log-linear capacitance
- Combined longitudinal and metallic protection
- Clamping speed of nanoseconds
- UL 94V-0 epoxy molding
- Pending UL recognized component
- Low clamping voltage

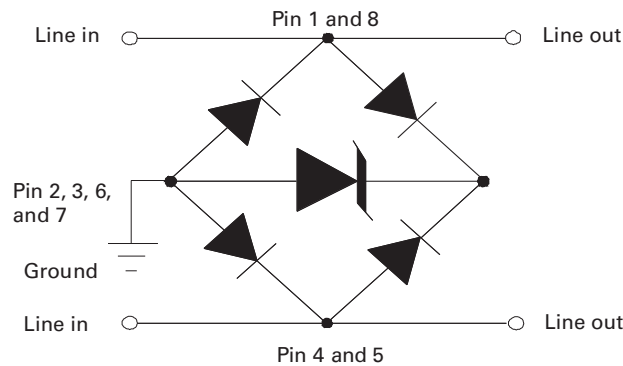
**Pinout**



**Applications**

- T1/E1 Line cards
- T3/E3 and DS3 Interfaces
- STS-1 Interfaces
- 10/100/1000 BaseT Ethernet

**Functional Block Diagram**



Life Support Note:

**Not Intended for Use in Life Support or Life Saving Applications**

The products shown herein are not designed for use in life sustaining or life saving applications unless otherwise expressly indicated.

### Absolute Maximum Ratings

Parameter	Rating	Units
Peak Pulse Current (8/20μs)	150	A
Peak Pulse Power (8/20μs)	2800	W
IEC 61000-4-2, Direct Discharge, (Level 4)	30	kV
IEC 61000-4-2, Air Discharge, (Level 4)	30	kV
IEC 61000-4-5 (8/20μs)	100	A
Telcordia GR 1089 (Intra-Building) (2/10μs)	100	A
ITU K.20 (5/310μs)	40	A

*CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.*

### Thermal Information

Parameter	Rating	Units
SOIC Package	170	°C/W
Operating Temperature Range	-55 to 125	°C
Storage Temperature Range	-65 to 150	°C
Maximum Junction Temperature	150	°C
Maximum Lead Temperature (Soldering 10s) (SOIC - Lead Tips Only)	260	°C

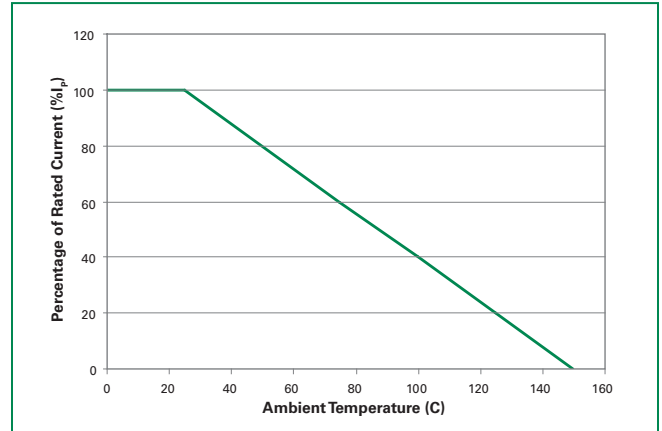
### Electrical Characteristics (T<sub>OP</sub> = 25°C)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Units
Reverse Stand-Off Voltage	V <sub>RWM</sub>	-	-	-	6	V
Reverse Breakdown Voltage	V <sub>BR</sub>	I <sub>T</sub> = 1mA	6.8	-	-	V
Reverse Leakage Current	I <sub>R</sub>	V <sub>RWM</sub> = 6V, T = 25°C	-	-	25	μA
Clamping Voltage, Line-Ground	V <sub>C</sub>	I <sub>PP</sub> = 50A, t <sub>p</sub> = 8/20 μs	-	-	15	V
Clamping Voltage, Line-Ground	V <sub>C</sub>	I <sub>PP</sub> = 100A, t <sub>p</sub> = 8/20 μs	-	-	20	V
Junction Capacitance	C <sub>J</sub> (Line-Ground)	Between I/O Pins and Ground V <sub>R</sub> = 0V, f = 1MHz	-	16	25	pF
	C <sub>J</sub> (Line-Line)	Between I/O Pins V <sub>R</sub> = 0V, f = 1MHz	-	8	12	pF

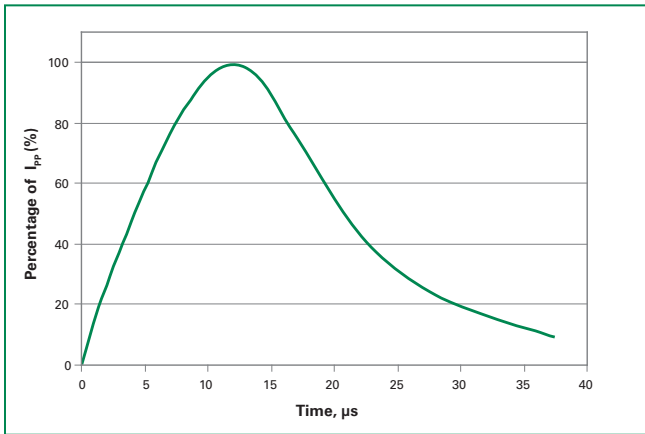
**Figure 1: Non-repetitive Peak Pulse Current vs. Pulse Time**



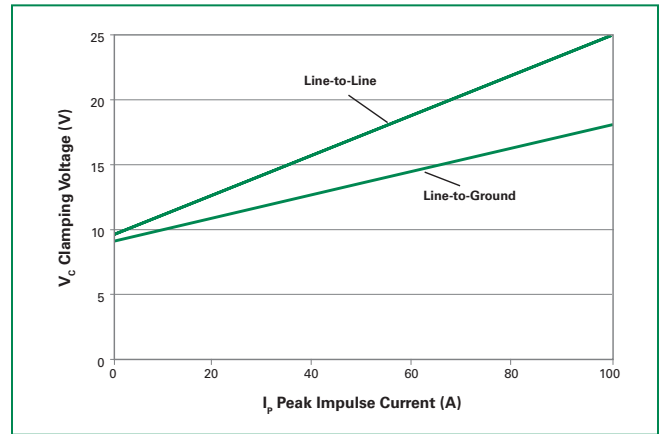
**Figure 2: Current Derating Curve**



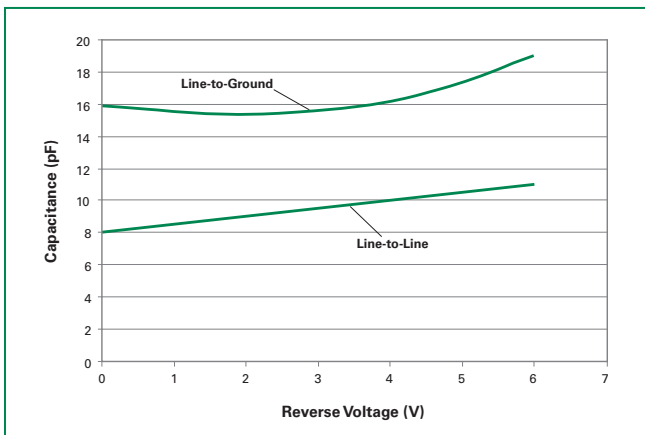
**Figure 3: Pulse Waveform**



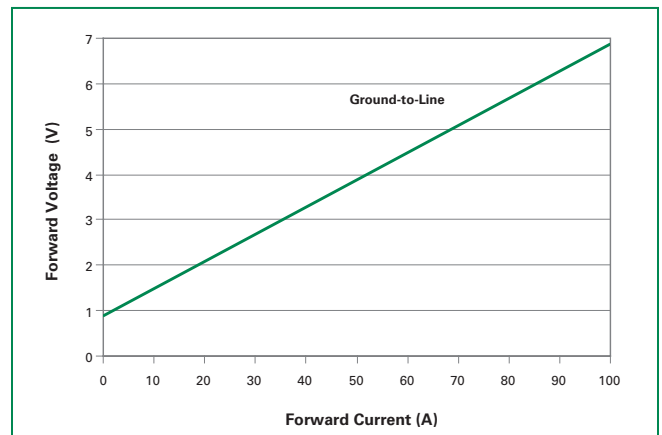
**Figure 4: Clamping Voltage vs. Peak Pulse Current**



**Figure 5: Capacitance vs. Reverse Voltage**



**Figure 6: Forward Voltage vs. Forward Current**

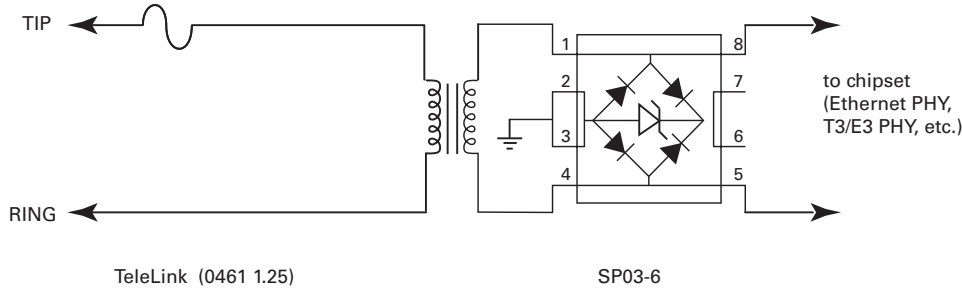


SP03-6 (SO-8)

### Application Example

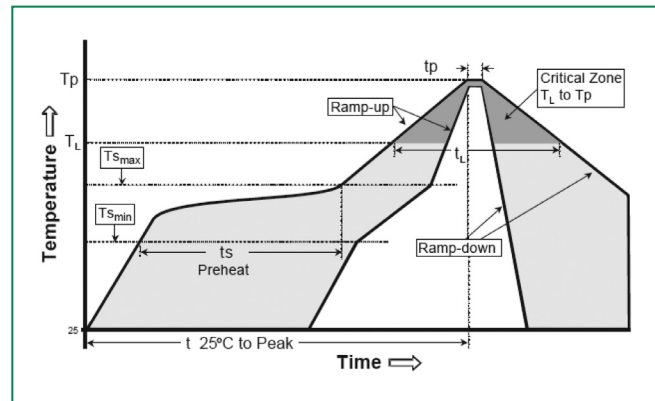
The following schematic shows a high-speed data interface protection solution. The SP03-6 provides both metallic (differential) and longitudinal (common mode) protection from lightning induced surge events. Its surge rating is compatible with the intra-building surge requirements of Telcordia's GR-1089-CORE, and the Basic Level

Recommendations of ITU K.20 and .21. This device protects against both positive and negative induced surge events. The TeleLink fuse provides overcurrent protection for the long term 50/60 Hz power fault events.

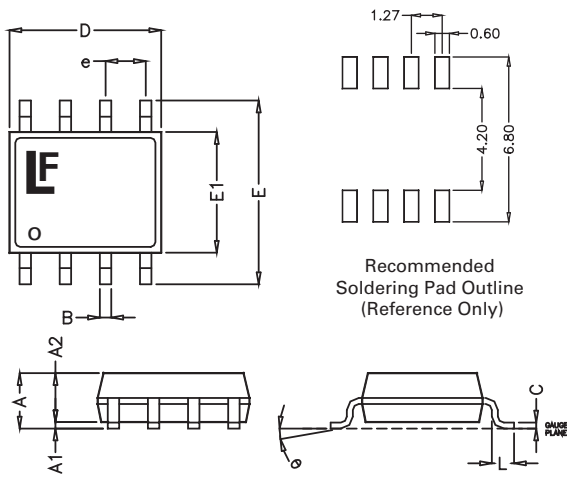


### Soldering Parameters

Reflow Condition		Pb – Free assembly
Pre Heat	- Temperature Min ( $T_{s(min)}$ )	150°C
	- Temperature Max ( $T_{s(max)}$ )	200°C
	- Time (min to max) ( $t_s$ )	60 – 180 secs
Average ramp up rate (Liquidus) Temp ( $T_L$ ) to peak		3°C/second max
$T_{s(max)}$ to $T_L$ - Ramp-up Rate		3°C/second max
Reflow	- Temperature ( $T_L$ ) (Liquidus)	217°C
	- Temperature ( $t_L$ )	60 – 150 seconds
Peak Temperature ( $T_p$ )		250 <sup>+0/-5</sup> °C
Time within 5°C of actual peak Temperature ( $t_p$ )		20 – 40 seconds
Ramp-down Rate		6°C/second max
Time 25°C to peak Temperature ( $T_p$ )		8 minutes Max.
Do not exceed		260°C

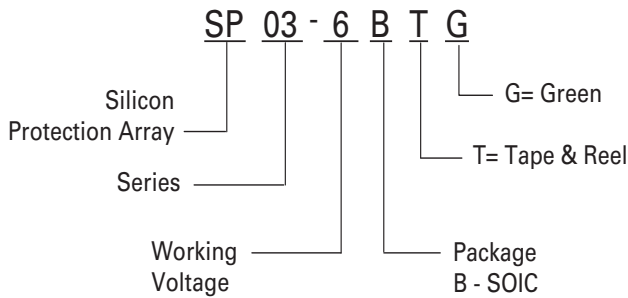


**Package Dimensions - Mechanical Drawings and Recommended Solder Pad Outline**



Package	MS-012 (SO-8)			
Pins	8			
JEDEC	MO-223 Issue A			
	Millimetres		Inches	
	Min	Max	Min	Max
<b>A</b>	1.35	1.75	0.053	0.069
<b>A1</b>	0.10	0.25	0.004	0.010
<b>A2</b>	1.25	1.65	0.049	0.065
<b>B</b>	0.31	0.51	0.012	0.020
<b>c</b>	0.17	0.25	0.007	0.010
<b>D</b>	4.80	5.00	0.189	0.197
<b>E</b>	5.80	6.20	0.228	0.244
<b>E1</b>	3.80	4.00	0.150	0.157
<b>e</b>	1.27 BSC		0.050 BSC	
<b>L</b>	0.40	1.27	0.016	0.050

**Part Numbering System**



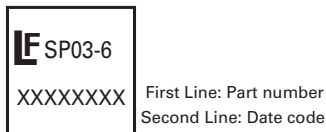
**Product Characteristics**

<b>Lead Plating</b>	Matte Tin
<b>Lead Material</b>	Copper Alloy
<b>Lead Coplanarity</b>	0.004 inches (0.102mm)
<b>Substitute Material</b>	Silicon
<b>Body Material</b>	Molded Epoxy
<b>Flammability</b>	UL94-V-0

Notes :

1. All dimensions are in millimeters
2. Dimensions include solder plating.
3. Dimensions are exclusive of mold flash & metal burr.
4. All specifications comply to JEDEC SPEC MO-223 Issue A
5. Blo is facing up for mold and facing down for trim/form, i.e. reverse trim/form.
6. Package surface matte finish VDI 11-13.

**Part Marking System**

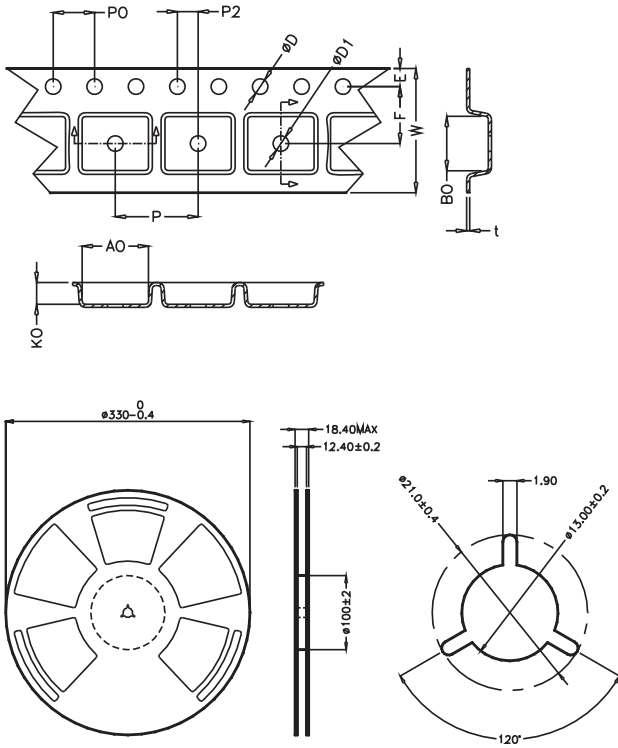


**Ordering Information**

Part Number	Package	Marking	Min. Order Qty.
SP03-6BTG	SOIC Tape & Reel	SP03-6	2500

SP03-6 (SO-8)

**Embossed Carrier Tape & Reel Specification - SOIC Package**



**Dimensions**

	Millimetres		Inches	
	Min	Max	Min	Max
<b>E</b>	1.65	1.85	0.065	0.073
<b>F</b>	5.4	5.6	0.213	0.22
<b>P2</b>	1.95	2.05	0.077	0.081
<b>D</b>	1.5	1.6	0.059	0.063
<b>D1</b>	1.50 Min		0.059 Min	
<b>P0</b>	3.9	4.1	0.154	0.161
<b>10P0</b>	40.0 +/- 0.20		1.574 +/- 0.008	
<b>W</b>	11.9	12.1	0.468	0.476
<b>P</b>	7.9	8.1	0.311	0.319
<b>A0</b>	6.3	6.5	0.248	0.256
<b>B0</b>	5.1	5.3	0.2	0.209
<b>K0</b>	2	2.2	0.079	0.087
<b>t</b>	0.30 +/- 0.05		0.012 +/- 0.002	